

Docket No.: GR 00 P 170



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Date: 10/16/01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Hans-Jürgen Hacke
Applic. No. : 09/833,260
Filed : April 10, 2001
Title : Electronic Component Having Microscopically Small Contact Areas and Method for Fabricating It

10/16/01
[Signature]

INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

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Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

United States Patent No. 5,420,461 (Mallik et al.), dated May 30, 1995;

United States Patent No. 5,706,174 (Distefano et al.), dated January 6, 1998;

United States Patent No. 5,753,973 (Yasunaga et al.), dated May 19, 1998;

United States Patent No. 5,904,498 (Fjelstad), dated May 18, 1999;

United States Patent No. 5,989,936 (Smith et al.), dated November 23, 1999;

German Published, Non-Prosecuted Patent Application DE 44 03 916 A1 (Park), dated September 1, 1994, method for producing a semiconductor chip contact point;

German Published, Non-Prosecuted Patent Application DE 197 23 203 A1 (You et al.), dated January 2, 1998, chip size semiconductor component and method for producing it;

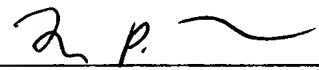
Japanese Patent Abstract JP 04 010 543 A (Okuaki), dated January 14, 1992;

Japanese Patent Abstract JP 05 175 199 A (Fujimoto et al.), dated July 13, 1993;

International Publication WO 96/14659 (Farnworth et al.), dated May 17, 1996.

If no translation of pertinent portions of any foreign language patents or publications mentioned above is included with the aforementioned copies of those applications, patents and/or publications, it is because no existing translation is readily available to the applicant.

Respectfully submitted,



For Applicant

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Date: October 10, 2001

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